

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	SKM100GAL12T4
Manufacturer:	SEMIKRON
Package:	Please confirm with sales
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/semikron/skm100gal12t4.html>

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New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

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Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.



SEMITRANS® 2

Fast IGBT4 Modules

SKM100GAL12T4

Features

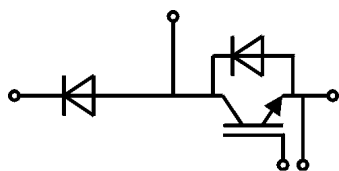
- IGBT4 = 4. generation fast trench IGBT (Infineon)
- CAL4 = Soft switching 4. generation CAL-diode
- Isolated copper baseplate using DBC technology (Direct Bonded Copper)
- Increased power cycling capability
- With integrated gate resistor
- For higher switching frequencies up to 20kHz
- UL recognized, file no. E63532

Typical Applications*

- Electronic welders at fsw up to 20 kHz
- DC/DC – converter
- Brake chopper
- Switched reluctance motor

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max.
- Recommended $T_{op} = -40 \dots +150^\circ\text{C}$
- Product reliability results valid for $T_j = 150^\circ\text{C}$



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Absolute Maximum Ratings

Symbol	Conditions	Values	Unit
IGBT			
V_{CES}	$T_j = 25^\circ\text{C}$	1200	V
I_C	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	160
		$T_c = 80^\circ\text{C}$	123
I_{Cnom}		100	A
I_{CRM}	$I_{CRM} = 3 \times I_{Cnom}$	300	A
V_{GES}		-20 ... 20	V
t_{psc}	$V_{CC} = 800\text{ V}$ $V_{GE} \leq 15\text{ V}$ $V_{CES} \leq 1200\text{ V}$	$T_j = 150^\circ\text{C}$	10
T_j		-40 ... 175	$^\circ\text{C}$

Inverse diode

I_F	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	121	A
		$T_c = 80^\circ\text{C}$	91	A
I_{Fnom}			100	A
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$		300	A
I_{FSM}	$t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$		550	A
T_j			-40 ... 175	$^\circ\text{C}$

Freewheeling diode

I_F	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	121	A
		$T_c = 80^\circ\text{C}$	91	A
I_{Fnom}			100	A
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$		300	A
I_{FSM}	$t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$		550	A
T_j			-40 ... 175	$^\circ\text{C}$

Module

$I_{t(RMS)}$	$T_{terminal} = 80^\circ\text{C}$	200	A
T_{stg}		-40 ... 125	$^\circ\text{C}$
V_{isol}	AC sinus 50 Hz, $t = 1\text{ min}$	4000	V

Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
IGBT					
$V_{CE(sat)}$	$I_C = 100\text{ A}$ $V_{GE} = 15\text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$	1.80	2.05	V
		$T_j = 150^\circ\text{C}$	2.20	2.40	V
V_{CE0}	chipelevel	$T_j = 25^\circ\text{C}$	0.8	0.9	V
		$T_j = 150^\circ\text{C}$	0.7	0.8	V
r_{CE}	$V_{GE} = 15\text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$	10.00	11.50	m Ω
		$T_j = 150^\circ\text{C}$	15.00	16.00	m Ω
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 3.8\text{ mA}$	5	5.8	6.5	V
I_{CES}	$V_{GE} = 0\text{ V}$ $V_{CE} = 1200\text{ V}$	$T_j = 25^\circ\text{C}$		1	mA
		$T_j = 150^\circ\text{C}$			mA
C_{ies}	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	6.15		nF
C_{oes}	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	0.40		nF
C_{res}	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	0.345		nF
Q_G	$V_{GE} = -8\text{ V} \dots +15\text{ V}$		565		nC
R_{Gint}	$T_j = 25^\circ\text{C}$		7.5		Ω



SEMITRANS® 2

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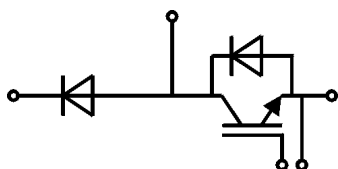
Typical Applications*

- Electronic welders at fsw up to 20 kHz
- DC/DC – converter
- Brake chopper
- Switched reluctance motor

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max.
- Recommended $T_{op} = -40 \dots +150^\circ\text{C}$
- Product reliability results valid for $T_j = 150^\circ\text{C}$

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
t _{d(on)}	V _{CC} = 600 V	T _j = 150 °C		165		ns
t _r	I _C = 100 A	T _j = 150 °C		47		ns
E _{on}	V _{GE} = ±15 V	T _j = 150 °C		15		mJ
t _{d(off)}	R _{G on} = 1 Ω	T _j = 150 °C		400		ns
t _f	R _{G off} = 1 Ω	T _j = 150 °C		75		ns
E _{off}	di/dt _{on} = 1800 A/μs	T _j = 150 °C		10.2		mJ
	di/dt _{off} = 1130 A/μs	T _j = 150 °C				
R _{th(j-c)}	per IGBT				0.27	K/W
Inverse diode						
V _F = V _{EC}	I _F = 100 A	T _j = 25 °C		2.20	2.52	V
	V _{GE} = 0 V	T _j = 150 °C		2.15	2.47	V
	chiplevel					
V _{F0}	chiplevel	T _j = 25 °C		1.3	1.5	V
		T _j = 150 °C		0.9	1.1	V
r _F	chiplevel	T _j = 25 °C		9.0	10.2	mΩ
		T _j = 150 °C		12.5	13.7	mΩ
I _{RRM}	I _F = 100 A	T _j = 150 °C		54		A
Q _{rr}	di/dt _{off} = 1600 A/μs	T _j = 150 °C		15.7		μC
E _{rr}	V _{GE} = ±15 V	T _j = 150 °C		5.9		mJ
	V _{CC} = 600 V					
R _{th(j-c)}	per diode				0.48	K/W
Freewheeling diode						
V _F = V _{EC}	I _F = 100 A	T _j = 25 °C		2.20	2.52	V
	V _{GE} = 0 V	T _j = 150 °C		2.15	2.47	V
	chiplevel					
V _{F0}	chiplevel	T _j = 25 °C		1.3	1.5	V
		T _j = 150 °C		0.9	1.1	V
r _F	chiplevel	T _j = 25 °C		9.0	10.2	mΩ
		T _j = 150 °C		12.5	13.7	mΩ
I _{RRM}	I _F = 100 A	T _j = 150 °C		54		A
Q _{rr}	di/dt _{off} = 1600 A/μs	T _j = 150 °C		15.7		μC
E _{rr}	V _{GE} = ±15 V	T _j = 150 °C		5.9		mJ
	V _{CC} = 600 V					
R _{th(j-c)}	per Diode				0.48	K/W
Module						
L _{CE}					30	nH
R _{CC'+EE'}	terminal-chip	T _C = 25 °C		0.65		mΩ
		T _C = 125 °C		1		mΩ
R _{th(c-s)}	per module			0.04	0.05	K/W
M _s	to heat sink M6		3		5	Nm
M _t		to terminals M5	2.5		5	Nm
						Nm
w					160	g



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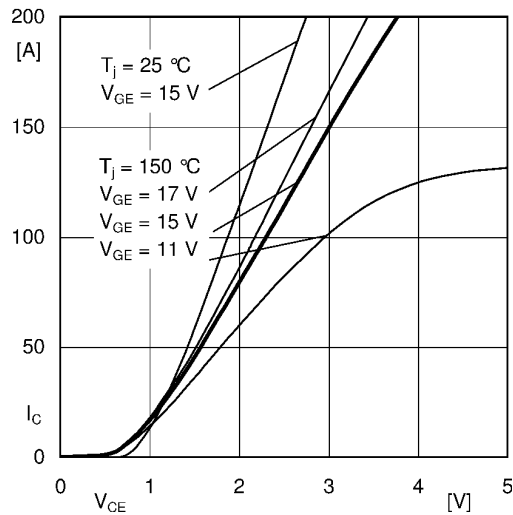


Fig. 1: Typ. output characteristic, inclusive $R_{CC} + EE'$

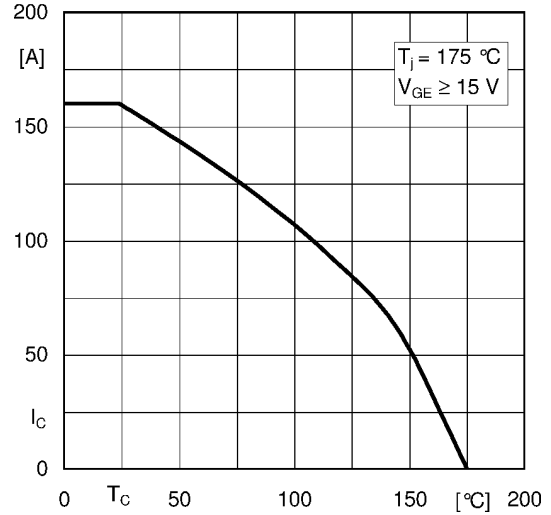


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

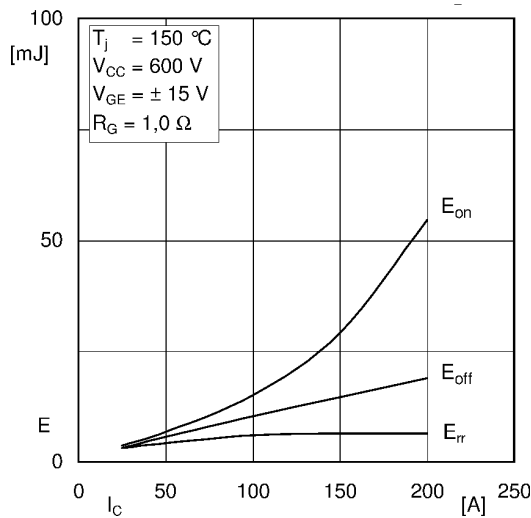


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

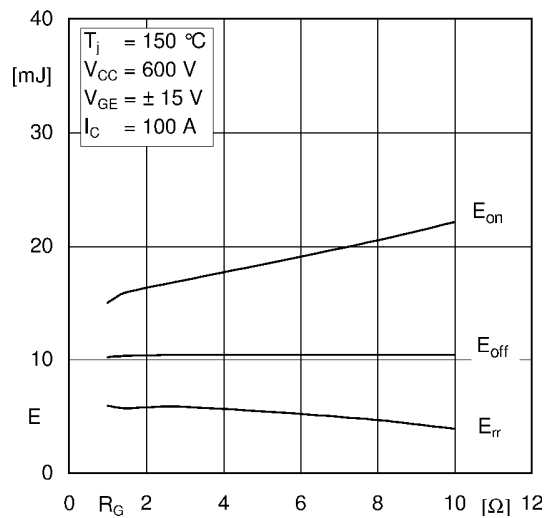


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

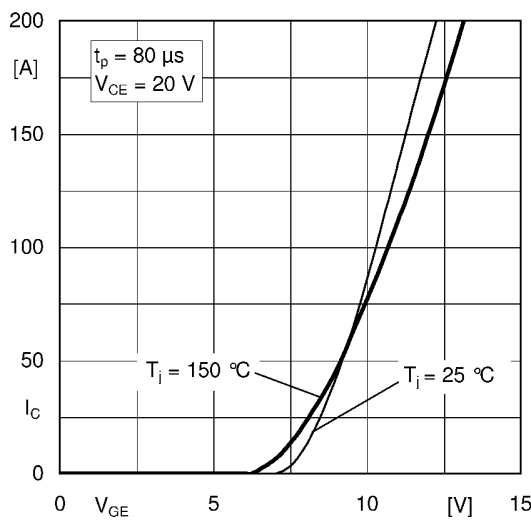


Fig. 5: Typ. transfer characteristic

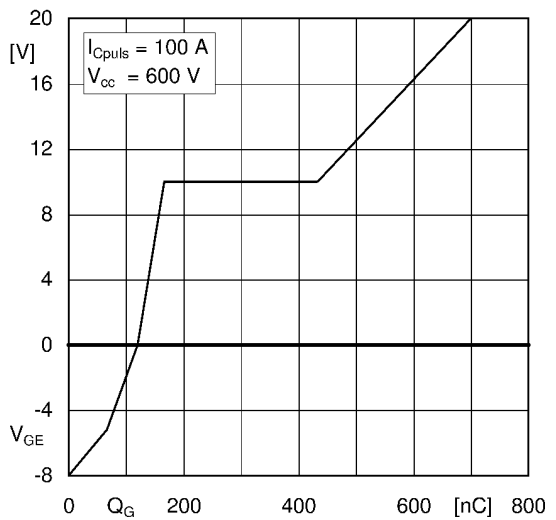
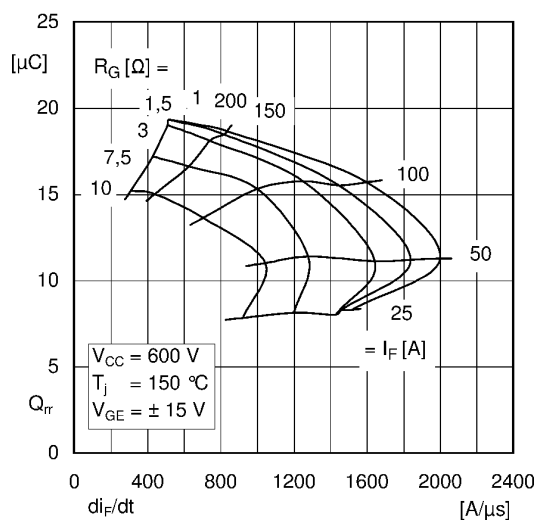
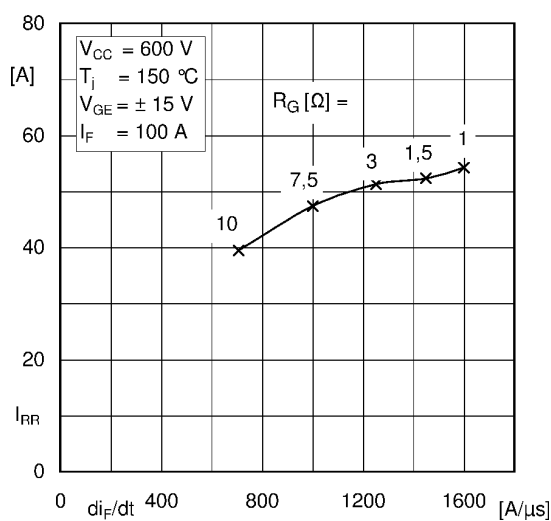
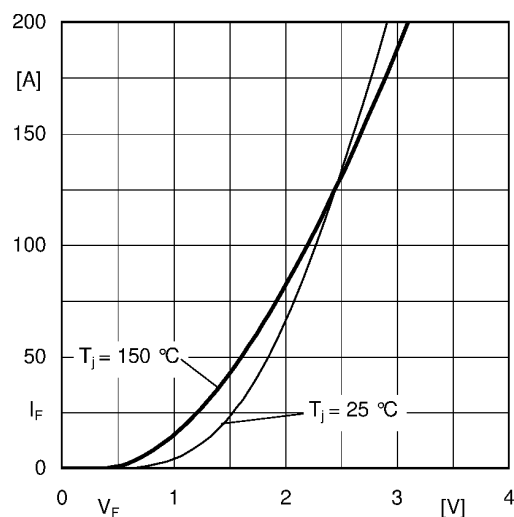
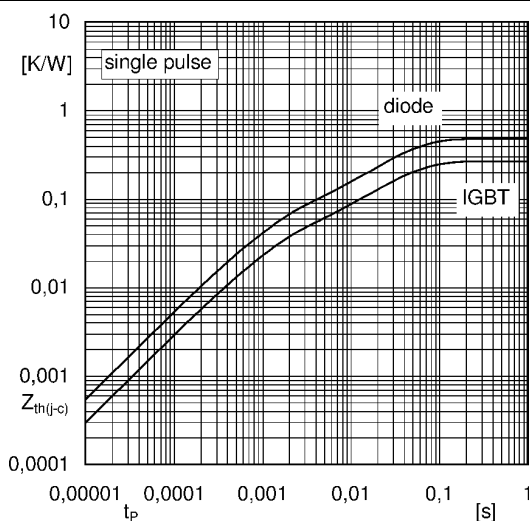
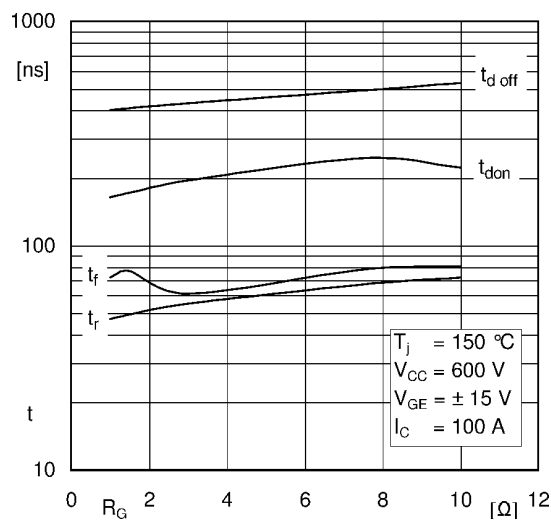
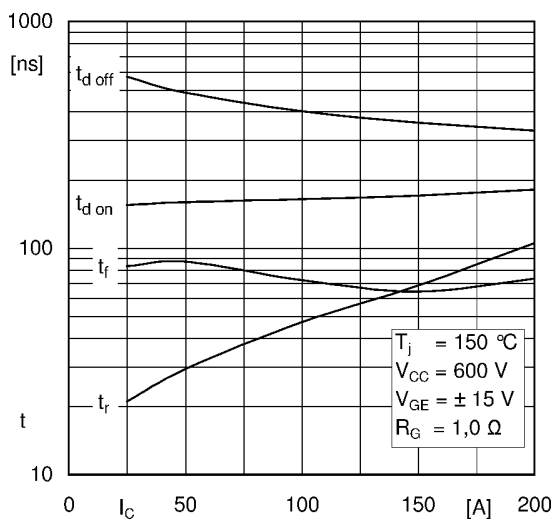
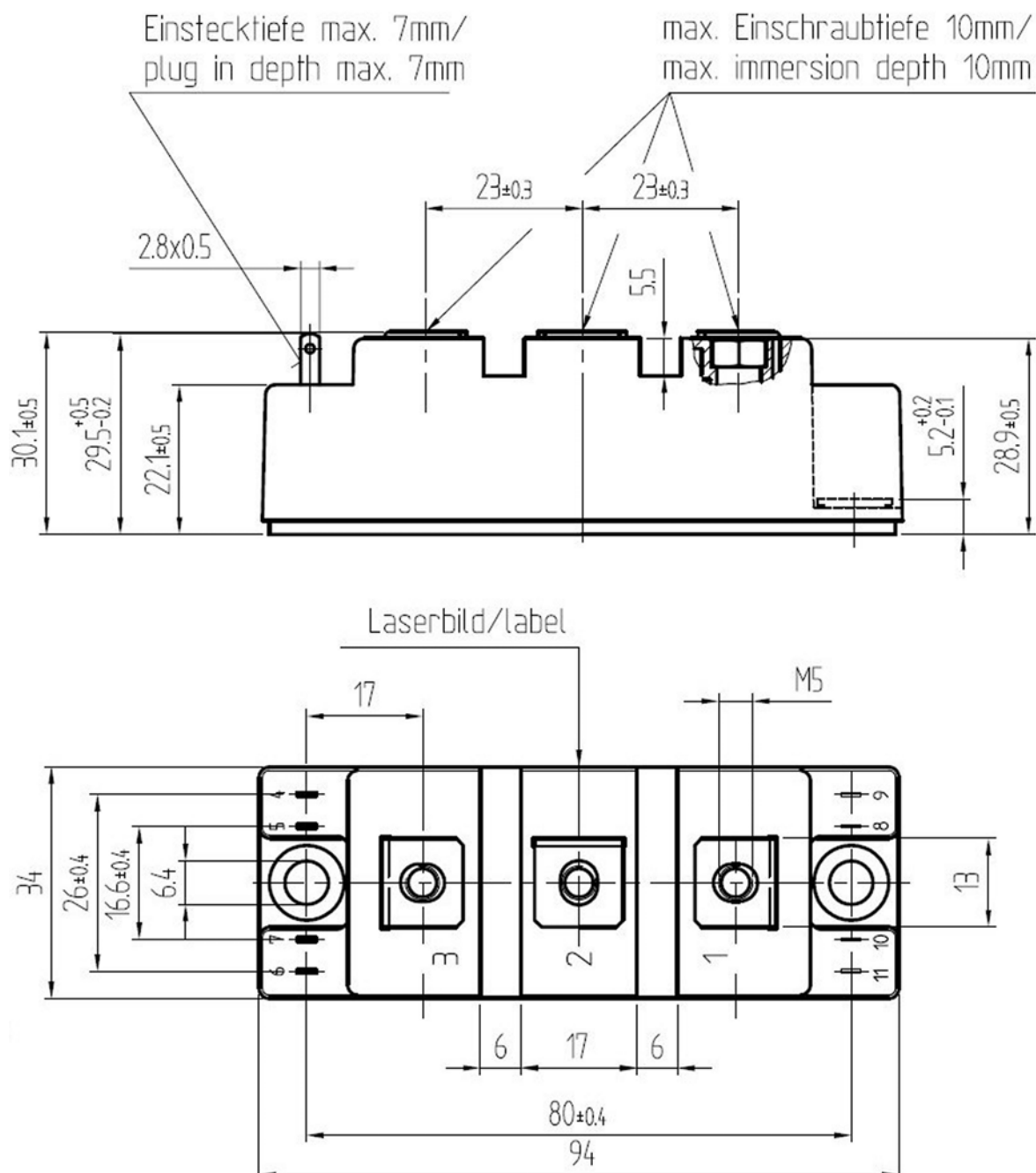
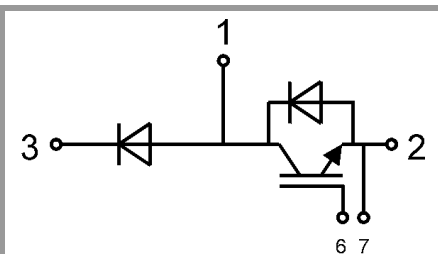


Fig. 6: Typ. gate charge characteristic





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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.